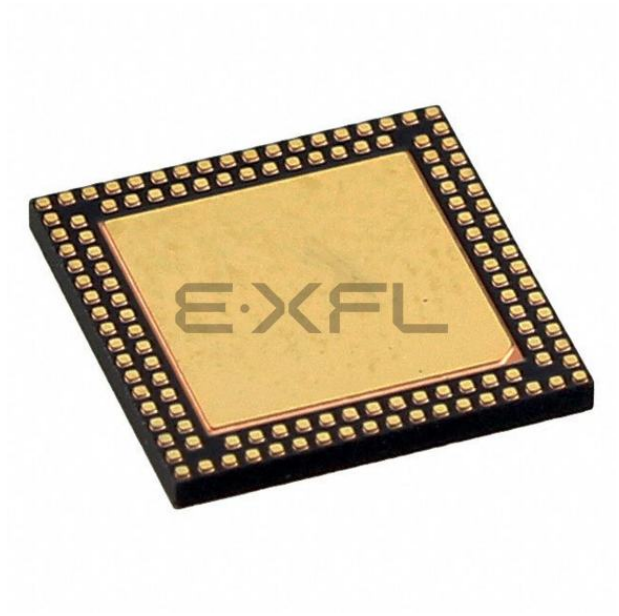

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	MIPS32® M-Class
Core Size	32-Bit Single-Core
Speed	200MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, PMP, SPI, SQI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	97
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.1V ~ 3.6V
Data Converters	A/D 48x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	124-VFTLA Dual Rows, Exposed Pad
Supplier Device Package	124-VTLA (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mz0512efk124-i-tl

TABLE 5: PIN NAMES FOR 144-PIN DEVICES (CONTINUED)

144-PIN LQFP AND TQFP (TOP VIEW)

PIC32MZ0512EF(E/F/K)144
PIC32MZ1024EF(G/H/M)144
PIC32MZ1024EF(E/F/K)144
PIC32MZ2048EF(G/H/M)144

144

1

Pin Number	Full Pin Name	Pin Number	Full Pin Name
73	VBUS	109	RPD1/SCK1/RD1
74	VUSB3V3	110	EBID14/RPD2/PMD14/RD2
75	VSS	111	EBID15/RPD3/PMD15/RD3
76	D-	112	EBID12/RPD12/PMD12/RD12
77	D+	113	EBID13/PMD13/RD13
78	RPF3/USBID/RF3	114	ETXERR/RJ0
79	SDA3/RPF2/RF2	115	EMDIO/RJ1
80	SCL3/RPF8/RF8	116	EBIRDY3/RJ2
81	ERXD0/RH8	117	EBIA22/RJ3
82	ERXD3/RH9	118	$\overline{\text{SQICS0}}$/RPD4/RD4
83	ECOL/RH10	119	$\overline{\text{SQICS1}}$/RPD5/RD5
84	EBIRDY2/RH11	120	ETXEN/RPD6/RD6
85	SCL2/RA2	121	ETXCLK/RPD7/RD7
86	EBIRDY1/SDA2/RA3	122	VDD
87	EBIA14/PMCS1/PMA14/RA4	123	VSS
88	VDD	124	EBID11/RPF0/PMD11/RF0
89	VSS	125	EBID10/RPF1/PMD10/RF1
90	EBIA9/RPF4/SDA5/PMA9/RF4	126	EBIA21/RK7
91	EBIA8/RPF5/SCL5/PMA8/RF5	127	EBID9/RPG1/PMD9/RG1
92	EBIA18/RK4	128	EBID8/RPG0/PMD8/RG0
93	EBIA19/RK5	129	TRCLK/SQICLK/RA6
94	EBIA20/RK6	130	TRD3/SQID3/RA7
95	RPA14/SCL1/RA14	131	$\overline{\text{EBICS0}}$/RJ4
96	RPA15/SDA1/RA15	132	$\overline{\text{EBICS1}}$/RJ5
97	EBIA15/RPD9/PMCS2/PMA15/RD9	133	$\overline{\text{EBICS2}}$/RJ6
98	RPD10/SCK4/RD10	134	$\overline{\text{EBICS3}}$/RJ7
99	EMDC/RPD11/RD11	135	EBID0/PMD0/RE0
100	ECRS/RH12	136	VSS
101	ERXDV/ECRSDV/RH13	137	VDD
102	RH14	138	EBID1/PMD1/RE1
103	EBIA23/RH15	139	TRD2/SQID2/RG14
104	RPD0/RTCC/INT0/RD0	140	TRD1/SQID1/RG12
105	SOSCI/RPC13/RC13	141	TRD0/SQID0/RG13
106	SOSCO/RPC14/T1CK/RC14	142	EBID2/PMD2/RE2
107	VDD	143	EBID3/RPE3/PMD3/RE3
108	VSS	144	EBID4/AN18/PMD4/RE4

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and **Section 12.4 "Peripheral Pin Select (PPS)"** for restrictions.

2: Every I/O port pin (RAx-RKx) can be used as a change notification pin (CNAx-CNKx). See **Section 12.0 "I/O Ports"** for more information.

3: Shaded pins are 5V tolerant.

TABLE 1-4: OC1 THROUGH OC9 PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	64-pin QFN/ TQFP	100-pin TQFP	124-pin VTLA	144-pin TQFP/ LQFP			
Output Compare							
OC1	PPS	PPS	PPS	PPS	O	—	Output Compare Outputs 1-9
OC2	PPS	PPS	PPS	PPS	O	—	
OC3	PPS	PPS	PPS	PPS	O	—	
OC4	PPS	PPS	PPS	PPS	O	—	
OC5	PPS	PPS	PPS	PPS	O	—	
OC6	PPS	PPS	PPS	PPS	O	—	
OC7	PPS	PPS	PPS	PPS	O	—	
OC8	PPS	PPS	PPS	PPS	O	—	
OC9	PPS	PPS	PPS	PPS	O	—	
OCFA	PPS	PPS	PPS	PPS	I	ST	Output Compare Fault A Input
OCFB	30	44	B24	62	I	ST	Output Compare Fault B Input

Legend: CMOS = CMOS-compatible input or output; Analog = Analog input; P = Power
ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input
TTL = Transistor-transistor Logic input buffer; PPS = Peripheral Pin Select

TABLE 1-5: EXTERNAL INTERRUPTS PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	64-pin QFN/ TQFP	100-pin TQFP	124-pin VTLA	144-pin TQFP/ LQFP			
External Interrupts							
INT0	46	71	A48	104	I	ST	External Interrupt 0
INT1	PPS	PPS	PPS	PPS	I	ST	External Interrupt 1
INT2	PPS	PPS	PPS	PPS	I	ST	External Interrupt 2
INT3	PPS	PPS	PPS	PPS	I	ST	External Interrupt 3
INT4	PPS	PPS	PPS	PPS	I	ST	External Interrupt 4

Legend: CMOS = CMOS-compatible input or output; Analog = Analog input; P = Power
ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input
TTL = Transistor-transistor Logic input buffer; PPS = Peripheral Pin Select

2.9 Designing for High-Speed Peripherals

The PIC32MZ EF family devices have peripherals that operate at frequencies much higher than typical for an embedded environment. Table 2-1 lists the peripherals that produce high-speed signals on their external pins:

TABLE 2-1: PERIPHERALS THAT PRODUCE HS SIGNALS ON EXTERNAL PINS

Peripheral	High-Speed Signal Pins	Maximum Speed on Signal Pin
EBI	EBIAx, EBIDx	50 MHz
SQI1	SQICLK, SQICSx, SQIDx	50 MHz
HS USB	D+, D-	480 MHz

Due to these high-speed signals, it is important to consider several factors when designing a product that uses these peripherals, as well as the PCB on which these components will be placed. Adhering to these recommendations will help achieve the following goals:

- Minimize the effects of electromagnetic interference to the proper operation of the product
- Ensure signals arrive at their intended destination at the same time
- Minimize crosstalk
- Maintain signal integrity
- Reduce system noise
- Minimize ground bounce and power sag

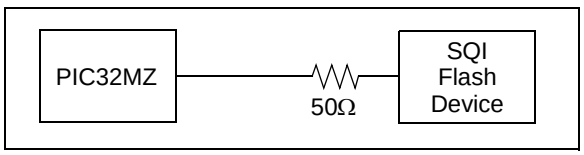
2.9.1 SYSTEM DESIGN

2.9.1.1 Impedance Matching

When selecting parts to place on high-speed buses, particularly the SQI bus, if the impedance of the peripheral device does not match the impedance of the pins on the PIC32MZ EF device to which it is connected, signal reflections could result, thereby degrading the quality of the signal.

If it is not possible to select a product that matches impedance, place a series resistor at the load to create the matching impedance. See Figure 2-4 for an example.

FIGURE 2-4: SERIES RESISTOR



2.9.1.2 PCB Layout Recommendations

The following list contains recommendations that will help ensure the PCB layout will promote the goals previously listed.

- **Component Placement**
  - Place bypass capacitors as close to their component power and ground pins as possible, and place them on the same side of the PCB
  - Devices on the same bus that have larger setup times should be placed closer to the PIC32MZ EF device
- **Power and Ground**
  - Multi-layer PCBs will allow separate power and ground planes
  - Each ground pin should be connected to the ground plane individually
  - Place bypass capacitor vias as close to the pad as possible (preferably inside the pad)
  - If power and ground planes are not used, maximize width for power and ground traces
  - Use low-ESR, surface-mount bypass capacitors
- **Clocks and Oscillators**
  - Place crystals as close as possible to the PIC32MZ EF device OSC/SOSC pins
  - Do not route high-speed signals near the clock or oscillator
  - Avoid via usage and branches in clock lines (SQICLK)
  - Place termination resistors at the end of clock lines
- **Traces**
  - Higher-priority signals should have the shortest traces
  - Match trace lengths for parallel buses (EBIAx, EBIDx, SQIDx)
  - Avoid long run lengths on parallel traces to reduce coupling
  - Make the clock traces as straight as possible
  - Use rounded turns rather than right-angle turns
  - Have traces on different layers intersect on right angles to minimize crosstalk
  - Maximize the distance between traces, preferably no less than three times the trace width
  - Power traces should be as short and as wide as possible
  - High-speed traces should be placed close to the ground plane

The FPU implements a high-performance 7-stage pipeline:

- Decode, register read and unpack (FR stage)
- Multiply tree, double pumped for double (M1 stage)
- Multiply complete (M2 stage)
- Addition first step (A1 stage)
- Addition second and final step (A2 stage)
- Packing to IEEE format (FP stage)
- Register writeback (FW stage)

The FPU implements a bypass mechanism that allows the result of an operation to be forwarded directly to the instruction that needs it without having to write the result to the FPU register and then read it back.

Table 3-5 lists the Coprocessor 1 Registers for the FPU.

TABLE 3-5: FPU (CP1) REGISTERS

Register Number	Register Name	Function
0	FIR	Floating Point implementation register. Contains information that identifies the FPU.
25	FCCR	Floating Point condition codes register.
26	FEXR	Floating Point exceptions register.
28	FENR	Floating Point enables register.
31	FCSR	Floating Point Control and Status register.

3.2 Power Management

The processor core offers a number of power management features, including low-power design, active power management and power-down modes of operation. The core is a static design that supports slowing or halting the clocks, which reduces system power consumption during Idle periods.

3.2.1 INSTRUCTION-CONTROLLED POWER MANAGEMENT

The mechanism for invoking Power-Down mode is through execution of the `WAIT` instruction. For more information on power management, see **Section 33.0 "Power-Saving Features"**.

3.2.2 LOCAL CLOCK GATING

The majority of the power consumed by the processor core is in the clock tree and clocking registers. The PIC32MZ family makes extensive use of local gated-clocks to reduce this dynamic power consumption.

3.3 L1 Instruction and Data Caches

3.3.1 INSTRUCTION CACHE (I-CACHE)

The I-Cache is an on-core memory block of 16 Kbytes. Because the I-Cache is virtually indexed, the virtual-to-physical address translation occurs in parallel with the cache access rather than having to wait for the physical address translation. The tag holds 22 bits of physical address, a valid bit, and a lock bit. The LRU replacement bits are stored in a separate array.

The I-Cache block also contains and manages the instruction line fill buffer. Besides accumulating data to be written to the cache, instruction fetches that reference data in the line fill buffer are serviced either by a bypass of that data, or data coming from the external interface. The I-Cache control logic controls the bypass function.

The processor core supports I-Cache locking. Cache locking allows critical code or data segments to be locked into the cache on a per-line basis, enabling the system programmer to maximize the efficiency of the system cache.

The cache locking function is always available on all I-Cache entries. Entries can then be marked as locked or unlocked on a per entry basis using the `CACHE` instruction.

3.3.2 DATA CACHE (D-CACHE)

The D-Cache is an on-core memory block of 4 Kbytes. This virtually indexed, physically tagged cache is protected. Because the D-Cache is virtually indexed, the virtual-to-physical address translation occurs in parallel with the cache access. The tag holds 22 bits of physical address, a valid bit, and a lock bit. There is an additional array holding dirty bits and LRU replacement algorithm bits for each set of the cache.

In addition to I-Cache locking, the processor core also supports a D-Cache locking mechanism identical to the I-Cache. Critical data segments are locked into the cache on a per-line basis. The locked contents can be updated on a store hit, but cannot be selected for replacement on a cache miss.

The D-Cache locking function is always available on all D-Cache entries. Entries can then be marked as locked or unlocked on a per-entry basis using the `CACHE` instruction.

3.3.3 ATTRIBUTES

The processor core I-Cache and D-Cache attributes are listed in the Configuration registers (see Register 3-1 through Register 3-4).

TABLE 4-14: SYSTEM BUS TARGET 6 REGISTER MAP

Virtual Address (BF8F_#)	Register Name	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
9820	SBT6ELOG1	31:16	MULTI	—	—	—	CODE<3:0>				—	—	—	—	—	—	—	—	0000
		15:0	INITID<7:0>								REGION<3:0>				—	CMD<2:0>			0000
9824	SBT6ELOG2	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	GROUP<1:0>		0000
9828	SBT6ECON	31:16	—	—	—	—	—	—	—	ERRP	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
9830	SBT6ECLRS	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	CLEAR	0000
9838	SBT6ECLRM	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	CLEAR	0000
9840	SBT6REG0	31:16	BASE<21:6>																xxxx
		15:0	BASE<5:0>						PRI	—	SIZE<4:0>					—	—	—	xxxx
9850	SBT6RD0	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	xxxx
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0	xxxx
9858	SBT6WR0	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	xxxx
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0	xxxx
9860	SBT6REG1	31:16	BASE<21:6>																xxxx
		15:0	BASE<5:0>						PRI	—	SIZE<4:0>					—	—	—	xxxx
9870	SBT6RD1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	xxxx
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0	xxxx
9878	SBT6WR1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	xxxx
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0	xxxx

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.
Note: For reset values listed as 'xxxx', please refer to Table 4-6 for the actual reset values.

7.1 CPU Exceptions

CPU coprocessor 0 contains the logic for identifying and managing exceptions. Exceptions can be caused by a variety of sources, including boundary cases in data, external events or program errors. Table 7-1 lists the exception types in order of priority.

TABLE 7-1: MIPS32® M-CLASS MICROPROCESSOR CORE EXCEPTION TYPES

Exception Type (In Order of Priority)	Description	Branches to	Status Bits Set	Debug Bits Set	EXCCODE	XC32 Function Name
Highest Priority						
Reset	Assertion $\overline{\text{MCLR}}$ or a Power-on Reset (POR).	0xBFC0_0000	BEV, ERL	—	—	_on_reset
Soft Reset	Assertion of a software Reset.	0xBFC0_0000	BEV, SR, ERL	—	—	_on_reset
DSS	EJTAG debug single step.	0xBFC0_0480	—	DSS	—	—
DINT	EJTAG debug interrupt. Caused by the assertion of the external EJ_DINT input or by setting the EjtagBrk bit in the ECR register.	0xBFC0_0480	—	DINT	—	—
NMI	Assertion of NMI signal.	0xBFC0_0000	BEV, NMI, ERL	—	—	_nmi_handler
Machine Check	TLB write that conflicts with an existing entry.	EBASE+0x180	MCHECK, EXL	—	0x18	_general_exception_handler
Interrupt	Assertion of unmasked hardware or software interrupt signal.	See Table 7-2.	IPL<2:0>	—	0x00	See Table 7-2.
Deferred Watch	Deferred watch (unmasked by K|DM=>!(K|DM) transition).	EBASE+0x180	WP, EXL	—	0x17	_general_exception_handler
DIB	EJTAG debug hardware instruction break matched.	0xBFC0_0480	—	DIB	—	—
WATCH	A reference to an address that is in one of the Watch registers (fetch).	EBASE+0x180	EXL	—	0x17	_general_exception_handler
AdEL	Fetch address alignment error. Fetch reference to protected address.	EBASE+0x180	EXL	—	0x04	_general_exception_handler
TLBL	Fetch TLB miss or fetch TLB hit to page with V = 0.	EBASE if Status.EXL = 0	—	—	0x02	—
		EBASE+0x180 if Status.EXL == 1	—	—	0x02	_general_exception_handler
TLBL Execute Inhibit	An instruction fetch matched a valid TLB entry that had the XI bit set.	EBASE+0x180	EXL	—	0x14	_general_exception_handler
IBE	Instruction fetch bus error.	EBASE+0x180	EXL	—	0x06	_general_exception_handler

11.0 HI-SPEED USB WITH ON-THE-GO (OTG)

Note: This data sheet summarizes the features of the PIC32MZ EF family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 51. "Hi-Speed USB with On-The-Go (OTG)"** (DS60001326) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32).

The Universal Serial Bus (USB) module contains analog and digital components to provide a USB 2.0 embedded host, device, or OTG implementation with a minimum of external components.

The module supports Hi-Speed, Full-Speed, or Low-Speed in any of the operating modes. This module in Host mode is intended for use as an embedded host and therefore does not implement a UHCI or OHCI controller.

The USB module consists of the RAM controller, packet encode/decode, UTM synchronization, end-point control, a dedicated USB DMA controller, pull-up and pull-down resistors, and the register interface. A block diagram of the PIC32 USB OTG module is presented in Figure 11-1.

The USB module includes the following features:

- USB Hi-Speed, Full-Speed, and Low-Speed support for host and device
- USB OTG support with one or more Hi-Speed, Full-Speed, or Low-Speed device
- Integrated signaling resistors
- Integrated analog comparators for VBUS monitoring
- Integrated USB transceiver
- Transaction handshaking performed by hardware
- Integrated 8-channel DMA to access system RAM and Flash
- Seven transmit endpoints and seven receive endpoints, in addition to Endpoint 0
- Session Request Protocol (SRP) and Host Negotiation Protocol (HNP) support
- Suspend and resume signaling support
- Dynamic FIFO sizing
- Integrated RAM for the FIFOs, eliminating the need for system RAM for the FIFOs
- Link power management support

Note 1: The implementation and use of the USB specifications, as well as other third party specifications or technologies, may require licensing; including, but not limited to, USB Implementers Forum, Inc. (also referred to as USB-IF). The user is fully responsible for investigating and satisfying any applicable licensing obligations.

2: If the USB module is used, the Primary Oscillator (POSC) is limited to either 12 MHz or 24 MHz.

REGISTER 11-18: USBExTXA: USB ENDPOINT 'x' TRANSMIT ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	TXHUBPRT<6:0>						
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	MULTTRAN	TXHUBADD<6:0>						
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	TXFADDR<6:0>						

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **Unimplemented:** Read as '0'

bit 30-24 **TXHUBPRT<6:0>:** TX Hub Port bits (*Host mode*)

When a Low-Speed or Full-Speed device is connected to this endpoint through a Hi-Speed USB 2.0 hub, this field records the port number of that USB 2.0 hub.

bit 23 **MULTTRAN:** TX Hub Multiple Translators bit (*Host mode*)
1 = The USB 2.0 hub has multiple transaction translators
0 = The USB 2.0 hub has a single transaction translator

bit 22-16 **TXHUBADD<6:0>:** TX Hub Address bits (*Host mode*)

When a Low-Speed or Full-Speed device is connected to this endpoint through a Hi-Speed USB 2.0 hub, these bits record the address of the USB 2.0 hub.

bit 15-7 **Unimplemented:** Read as '0'

bit 6-0 **TXFADDR<6:0>:** TX Functional Address bits (*Host mode*)

Specifies the address for the target function that is be accessed through the associated endpoint. It needs to be defined for each TX endpoint that is used.

12.5 I/O Ports Control Registers

TABLE 12-4: PORTA REGISTER MAP FOR 100-PIN, 124-PIN, AND 144-PIN DEVICES ONLY

Virtual Address (BF86_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
0000	ANSELA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	ANSA10	ANSA9	—	—	—	ANSA5	—	—	—	ANSA1	ANSA0	0623
0010	TRISA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	TRISA15	TRISA14	—	—	—	TRISA10	TRISA9	—	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	C6FF
0020	PORTA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	RA15	RA14	—	—	—	RA10	RA9	—	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	xxxx
0030	LATA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	LATA15	LATA14	—	—	—	LATA10	LATA9	—	LATA7	LATA6	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	xxxx
0040	ODCA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ODCA15	ODCA14	—	—	—	ODCA10	ODCA9	—	ODCA7	ODCA6	ODCA5	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	0000
0050	CNPUA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CNPUA15	CNPUA14	—	—	—	CNPUA10	CNPUA9	—	CNPUA7	CNPUA6	CNPUA5	CNPUA4	CNPUA3	CNPUA2	CNPUA1	CNPUA0	0000
0060	CNPDA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CNPDA15	CNPDA14	—	—	—	CNPDA10	CNPDA9	—	CNPDA7	CNPDA6	CNPDA5	CNPDA4	CNPDA3	CNPDA2	CNPDA1	CNPDA0	0000
0070	CNCONA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	—	—	EDGEDETECT	—	—	—	—	—	—	—	—	—	—	—	0000
0080	CNENA	31:16	—	—				—	—		—	—	—	—	—	—	—	—	0000
		15:0	CNENA15	CNENA14	—	—	—	CNENA10	CNENA9		CNENA7	CNENA6	CNENA5	CNENA4	CNENA3	CNENA2	CNENA1	CNENA0	0000
0090	CNSTATA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CN STATA15	CN STATA14	—	—	—	CN STATA10	CN STATA9	—	CN STATA7	CN STATA6	CN STATA5	CN STATA4	CN STATA3	CN STATA2	CN STATA1	CN STATA0	0000
00A0	CNNEA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CNNEA15	CNNEA14	—	—	—	CNNEA10	CNNEA9	—	CNNEA7	CNNEA6	CNNEA5	CNNEA4	CNNEA3	CNNEA2	CNNEA1	CNNEA0	0000
00B0	CNFA	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CNFA15	CNFA14	—	—	—	CNFA10	CNFA9	—	CNFA7	CNFA76	CNFA5	CNFA4	CNFA3	CNFA2	CNFA71	CNFA0	0000
00C0	SRCON0A	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	SR0A7	SR0A6	—	—	—	—	—	—	0000
00D0	SRCON1A	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	SR1A7	SR0A6	—	—	—	—	—	—	0000

Legend: x = Unknown value on Reset; — = Unimplemented, read as '0'; Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.

TABLE 18-2: OUTPUT COMPARE 1 THROUGH OUTPUT COMPARE 9 REGISTER MAP (CONTINUED)

Virtual Address (BF84_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
4A00	OC6CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
4A10	OC6R	31:16	OC6R<31:0>																xxxx
		15:0																	xxxx
4A20	OC6RS	31:16	OC6RS<31:0>																xxxx
		15:0																	xxxx
4C00	OC7CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
4C10	OC7R	31:16	OC7R<31:0>																xxxx
		15:0																	xxxx
4C20	OC7RS	31:16	OC7RS<31:0>																xxxx
		15:0																	xxxx
4E00	OC8CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
4E10	OC8R	31:16	OC8R<31:0>																xxxx
		15:0																	xxxx
4E20	OC8RS	31:16	OC8RS<31:0>																xxxx
		15:0																	xxxx
5000	OC9CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
5010	OC9R	31:16	OC9R<31:0>																xxxx
		15:0																	xxxx
5020	OC9RS	31:16	OC9RS<31:0>																xxxx
		15:0																	

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.

REGISTER 19-1: SPIxCON: SPI CONTROL REGISTER (CONTINUED)

bit 17 **SPIFE:** Frame Sync Pulse Edge Select bit (Framed SPI mode only)
1 = Frame synchronization pulse coincides with the first bit clock
0 = Frame synchronization pulse precedes the first bit clock

bit 16 **ENHBUF:** Enhanced Buffer Enable bit(1)
1 = Enhanced Buffer mode is enabled
0 = Enhanced Buffer mode is disabled

bit 15 **ON:** SPI/I^2S Module On bit
1 = SPI/I^2S module is enabled
0 = SPI/I^2S module is disabled

bit 14 **Unimplemented:** Read as '0'

bit 13 **SIDL:** Stop in Idle Mode bit
1 = Discontinue operation when CPU enters in Idle mode
0 = Continue operation in Idle mode

bit 12 **DISSDO:** Disable SDOx pin bit(4)
1 = SDOx pin is not used by the module. Pin is controlled by associated PORT register
0 = SDOx pin is controlled by the module

bit 11-10 **MODE<32,16>:** 32/16-Bit Communication Select bits

When AUDEN = 1:

MODE32	MODE16	Communication
1	1	24-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame
1	0	32-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame
0	1	16-bit Data, 16-bit FIFO, 32-bit Channel/64-bit Frame
0	0	16-bit Data, 16-bit FIFO, 16-bit Channel/32-bit Frame

When AUDEN = 0:

MODE32	MODE16	Communication
1	x	32-bit
0	1	16-bit
0	0	8-bit

bit 9 **SMP:** SPI Data Input Sample Phase bit
Master mode (MSTEN = 1):
1 = Input data sampled at end of data output time
0 = Input data sampled at middle of data output time
Slave mode (MSTEN = 0):
SMP value is ignored when SPI is used in Slave mode. The module always uses SMP = 0.

bit 8 **CKE:** SPI Clock Edge Select bit(2)
1 = Serial output data changes on transition from active clock state to Idle clock state (see CKP bit)
0 = Serial output data changes on transition from Idle clock state to active clock state (see CKP bit)

bit 7 **SSEN:** Slave Select Enable (Slave mode) bit
1 = $\overline{SSx}$ pin is used for Slave mode
0 = SSx pin is not used for Slave mode, pin is controlled by the port function.

bit 6 **CKP:** Clock Polarity Select bit(3)
1 = Idle state for clock is a high level; active state is a low level
0 = Idle state for clock is a low level; active state is a high level

Note 1: This bit can only be written when the ON bit = 0. Refer to **Section 37.0 "Electrical Characteristics"** for maximum clock frequency requirements.

2: This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).

3: When AUDEN = 1, the SPI/I^2S module functions as if the CKP bit is equal to '1', regardless of the actual value of the CKP bit.

4: This bit present for legacy compatibility and is superseded by PPS functionality on these devices (see **Section 12.4 "Peripheral Pin Select (PPS)"** for more information).

REGISTER 26-6: CEINTSRC: CRYPTO ENGINE INTERRUPT SOURCE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	U-0	R-0	R-0	R-0	R-0
	—	—	—	—	AREIF	PKTIF	CBDIF	PENDIF

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-4 **Unimplemented:** Read as '0'

bit 3 **AREIF:** Access Response Error Interrupt bit
1 = Error occurred trying to access memory outside the Crypto Engine
0 = No error has occurred

bit 2 **PKTIF:** DMA Packet Completion Interrupt Status bit
1 = DMA packet was completed
0 = DMA packet was not completed

bit 1 **CBDIF:** BD Transmit Status bit
1 = Last BD transmit was processed
0 = Last BD transmit has not been processed

bit 0 **PENDIF:** Crypto Engine Interrupt Pending Status bit
1 = Crypto Engine interrupt is pending (this value is the result of an OR of all interrupts in the Crypto Engine)
0 = Crypto Engine interrupt is not pending

REGISTER 26-7: CEINTEN: CRYPTO ENGINE INTERRUPT ENABLE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	—	AREIE	PKTIE	BDPIE	PENDIE(1)

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-4 **Unimplemented:** Read as '0'

bit 3 **AREIE:** Access Response Error Interrupt Enable bit
- 1 = Access response error interrupts are enabled
- 0 = Access response error interrupts are not enabled

bit 2 **PKTIE:** DMA Packet Completion Interrupt Enable bit
- 1 = DMA packet completion interrupts are enabled
- 0 = DMA packet completion interrupts are not enabled

bit 1 **BDPIE:** DMA Buffer Descriptor Processor Interrupt Enable bit
- 1 = BDP interrupts are enabled
- 0 = BDP interrupts are not enabled

bit 0 **PENDIE:** Master Interrupt Enable bit(1)
- 1 = Crypto Engine interrupts are enabled
- 0 = Crypto Engine interrupts are not enabled

Note 1: The PENDIE bit is a global enable bit and must be enabled together with the other interrupts desired.

REGISTER 27-2: RNGCON: RANDOM NUMBER GENERATOR CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	LOAD	TRNGMODE	CONT	PRNGEN	TRNGEN
7:0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-1	R/W-0	R/W-0
	PLEN<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-13 **Unimplemented:** Read as '0'

bit 12 **LOAD:** Device Select bit

This bit is self-clearing and is used to load the seed from the TRNG (i.e., the random value) as a seed to the PRNG.

bit 11 **TRNGMODE:** TRNG Mode Selection bit

1 = Use ring oscillators with bias corrector
0 = Use ring oscillators with XOR tree

Note: Enabling this bit will generate numbers with a more even distribution of randomness.

bit 10 **CONT:** PRNG Number Shift Enable bit

1 = The PRNG random number is shifted every cycle
0 = The PRNG random number is shifted when the previous value is removed

bit 9 **PRNGEN:** PRNG Operation Enable bit

1 = PRNG operation is enabled
0 = PRNG operation is not enabled

bit 8 **TRNGEN:** TRNG Operation Enable bit

1 = TRNG operation is enabled
0 = TRNG operation is not enabled

bit 7-0 **PLEN<7:0>:** PRNG Polynomial Length bits

These bits contain the length of the polynomial used for the PRNG.

REGISTER 28-7: ADCIMCON3: ADC INPUT MODE CONTROL REGISTER 3 (CONTINUED)

bit 1 **DIFF32:** AN32 Mode bit(1)
1 = AN32 is using Differential mode
0 = AN32 is using Single-ended mode

bit 0 **SIGN32:** AN32 Signed Data Mode bit(1)
1 = AN32 is using Signed Data mode
0 = AN32 is using Unsigned Data mode

Note 1: This bit is not available on 64-pin devices.
2: This bit is not available on 64-pin and 100-pin devices.

REGISTER 30-9: ETHPMCS: ETHERNET CONTROLLER PATTERN MATCH CHECKSUM REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	PMCS<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	PMCS<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15-8 **PMCS<15:8>:** Pattern Match Checksum 1 bits

bit 7-0 **PMCS<7:0>:** Pattern Match Checksum 0 bits

Note 1: This register is only used for RX operations.

2: The bits in this register may only be changed while the RXEN bit (ETHCON1<8>) = 0 or the PMMODE bit (ETHRXFC<11:8>) = 0.

REGISTER 30-10: ETHPMO: ETHERNET CONTROLLER PATTERN MATCH OFFSET REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	PMO<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	PMO<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15-0 **PMO<15:0>:** Pattern Match Offset 1 bits

Note 1: This register is only used for RX operations.

2: The bits in this register may only be changed while the RXEN bit (ETHCON1<8>) = 0 or the PMMODE bit (ETHRXFC<11:8>) = 0.

REGISTER 34-7: CFGCON: CONFIGURATION CONTROL REGISTER (CONTINUED)

bit 7 **IOANCPEN:** I/O Analog Charge Pump Enable bit
The analog IO charge pump improves analog performance when the device is operating at lower voltages. However, the charge pumps consume additional current.
1 = Charge pump is enabled
0 = Charge pump is disabled

bit 6 **Unimplemented:** Read as '0'

bit 5-4 **ECCCON<1:0>:** Flash ECC Configuration bits
11 = ECC and dynamic ECC are disabled (ECCCON<1:0> bits are writable)
10 = ECC and dynamic ECC are disabled (ECCCON<1:0> bits are locked)
01 = Dynamic Flash ECC is enabled (ECCCON<1:0> bits are locked)
00 = Flash ECC is enabled (ECCCON<1:0> bits are locked; disables word Flash writes)

bit 3 **JTAGEN:** JTAG Port Enable bit
1 = Enable the JTAG port
0 = Disable the JTAG port

bit 2 **TROEN:** Trace Output Enable bit
1 = Enable trace outputs and start trace clock (trace probe must be present)
0 = Disable trace outputs and stop trace clock

bit 1 **Unimplemented:** Read as '0'

bit 0 **TDOEN:** TDO Enable for 2-Wire JTAG
1 = 2-wire JTAG protocol uses TDO
0 = 2-wire JTAG protocol does not use TDO

Note 1: To change this bit, the unlock sequence must be performed. Refer to **Section 42. "Oscillators with Enhanced PLL"** (DS60001250) in the *"PIC32 Family Reference Manual"* for details.

37.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC32MZ EF electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC32MZ EF devices are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions, above the parameters indicated in the operation listings of this specification, is not implied.

Specifications for Extended Temperature devices (-40ºC to +125ºC) that are different from the specifications in this section are provided in **38.0 "Extended Temperature Electrical Characteristics"**.

Absolute Maximum Ratings

(See Note 1)

Ambient temperature under bias ..... -40°C to +85°C
Storage temperature ..... -65°C to +150°C
Voltage on V_{DD} with respect to V_{SS} ..... -0.3V to +4.0V
Voltage on any pin that is not 5V tolerant, with respect to V_{SS} **(Note 3)** ..... -0.3V to (V_{DD} + 0.3V)
Voltage on any 5V tolerant pin with respect to V_{SS} when $V_{DD} \geq 2.1V$ **(Note 3)** ..... -0.3V to +5.5V
Voltage on any 5V tolerant pin with respect to V_{SS} when $V_{DD} < 2.1V$ **(Note 3)** ..... -0.3V to +3.6V
Voltage on D+ or D- pin with respect to V_{USB3V3} ..... -0.3V to (V_{USB3V3} + 0.3V)
Voltage on V_{BUS} with respect to V_{SS} ..... -0.3V to +5.5V
Maximum current out of V_{SS} pin(s) ..... 200 mA
Maximum current into V_{DD} pin(s) **(Note 2)** ..... 200 mA
Maximum current sunk/sourced by any 4x I/O pin **(Note 4)** ..... 15 mA
Maximum current sunk/sourced by any 8x I/O pin **(Note 4)** ..... 25 mA
Maximum current sunk/sourced by any 12x I/O pin **(Note 4)** ..... 33 mA
Maximum current sunk by all ports ..... 150 mA
Maximum current sourced by all ports **(Note 2)** ..... 150 mA

Note 1: Stresses above those listed under **"Absolute Maximum Ratings"** may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions, above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

2: Maximum allowable current is a function of device maximum power dissipation (see Table 37-2).

3: See the pin name tables (Table 2 through Table 4) for the 5V tolerant pins.

4: Characterized, but not tested. Refer to parameters DO10, DO20, and DO20a for the 4x, 8x, and 12x I/O pin lists.

TABLE 37-11: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	**Sym.**	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions(1)**
DO20a	VOH1	**Output High Voltage** I/O Pins: 4x Source Driver Pins - RA3, RA9, RA10, RA14, RA15 RB0-RB2, RB4, RB6-RB7, RB11, RB13 RC12-RC15 RD0, RD6-RD7, RD11, RD14 RE8, RE9 RF2, RF3, RF8 RG15 RH0, RH1, RH4-RH6, RH8-RH13 RJ0-RJ2, RJ8, RJ9, RJ11	1.5	—	—	V	IOH ≥ -14 mA, VDD = 3.3V
			2.0	—	—	V	IOH ≥ -12 mA, VDD = 3.3V
			3.0	—	—	V	IOH ≥ -7 mA, VDD = 3.3V
		Output High Voltage I/O Pins: 8x Source Driver Pins - RA0-RA2, RA4, RA5 RB3, RB5, RB8-RB10, RB12, RB14, RB15 RC1-RC4 RD1-RD5, RD9, RD10, RD12, RD13, RD15 RE4-RE7 RF0, RF4, RF5, RF12, RF13 RG0, RG1, RG6-RG9 RH2, RH3, RH7, RH14, RH15 RJ3-RJ7, RJ10, RJ12-RJ15 RK0-RK7	1.5	—	—	V	IOH ≥ -22 mA, VDD = 3.3V
			2.0	—	—	V	IOH ≥ -18 mA, VDD = 3.3V
			3.0	—	—	V	IOH ≥ -10 mA, VDD = 3.3V
		Output High Voltage I/O Pins: 12x Source Driver Pins - RA6, RA7 RE0-RE3 RF1 RG12-RG14	1.5	—	—	V	IOH ≥ -32 mA, VDD = 3.3V
			2.0	—	—	V	IOH ≥ -25 mA, VDD = 3.3V
			3.0	—	—	V	IOH ≥ -14 mA, VDD = 3.3V

Note 1: Parameters are characterized, but not tested.

A.10 Package Differences

In general, PIC32MZ EF devices are mostly pin compatible with PIC32MX5XX/6XX/7XX devices; however, some pins are not. In particular, the VDD and VSS pins have been added and moved to different pins. In addition, I/O functions that were on fixed pins now will largely be on remappable pins.

TABLE A-11: PACKAGE DIFFERENCES

PIC32MX5XX/6XX/7XX Feature	PIC32MZ EF Feature
VCAP Pin	
On PIC32MX devices, an external capacitor is required between a VCAP pin and GND, which provides a filtering capacitor for the internal voltage regulator.	On PIC32MZ EF devices, this requirement has been removed.
A low-ESR capacitor (typically 10 µF) is required on the VCAP pin.	No VCAP pin.
VDD and VSS Pins	
	There are more VDD pins on PIC32MZ EF devices, and many are located on different pins.
VDD on 64-pin packages: 10, 26, 38, 57 VDD on 100-pin packages: 2, 16, 37, 46, 62, 86	VDD on 64-pin packages: 8, 26, 39, 54, 60 VDD on 100-pin packages: 14, 37, 46, 62, 74, 83, 93
	There are more VSS pins on PIC32MZ EF devices, and many are located on different pins.
VSS on 64-pin packages: 9, 25, 41 VSS on 100-pin packages: 15, 36, 45, 65, 75	VSS on 64-pin packages: 7, 25, 35, 40, 55, 59 VSS on 100-pin packages: 13, 36, 45, 53, 63, 75, 84, 92
PPS I/O Pins	
	Peripheral functions on PIC32MZ EF devices are now routed through a PPS module, which routes the signals to the desired pins. When migrating software, it is necessary to initialize the PPS I/O functions in order to get the signal to and from the correct pin.
All peripheral functions are fixed as to what pin upon which they operate.	PPS functionality for the following peripherals: • CAN • UART • SPI (except SCK) • Input Capture • Output Compare • External Interrupt (except INT0) • Timer Clocks (except Timer1) • Reference Clocks (except REFCLK2)